



CHALLENGES OF PACKAGING PHOTONIC DEVICES

George Lutes and Meirong Tu

**Jet Propulsion Laboratory
4800 Oak Grove Drive
Pasadena, CA 91109**



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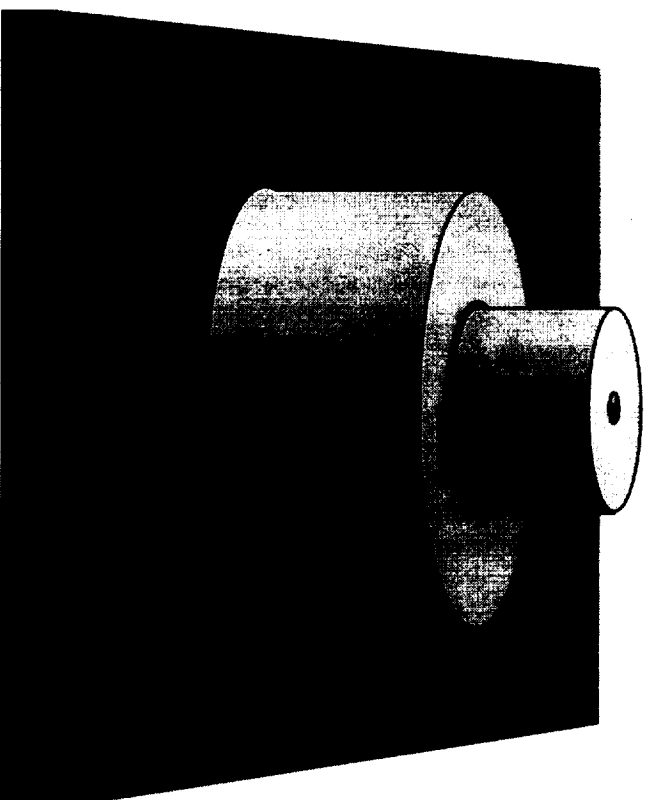
PROBLEMS

- **Must be positioned to submicron tolerances**
- **Must be fastened in place while maintaining the position to within submicrons**
- **Must not move more than a fraction of a micron with time**
- **Must maintain submicron tolerances under high vibration, humidity, and temperature extremes**



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TYPICAL POSITIONING TECHNIQUE USED TODAY

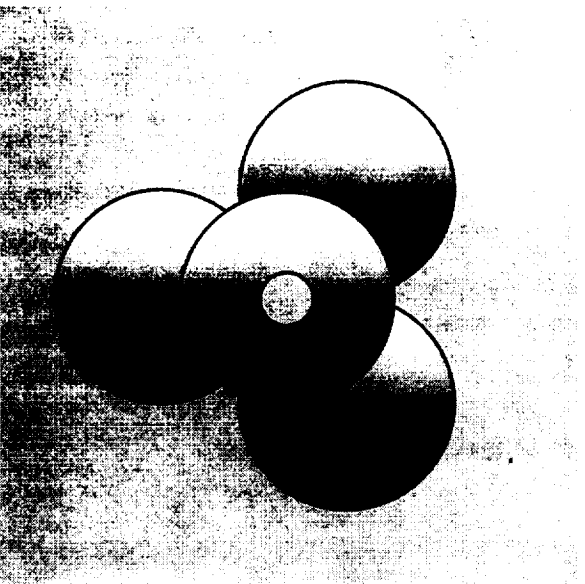


**MOUNTING PLATFORM IS NOT DECOUPLED FROM THE
FASTENING MECHANISM**

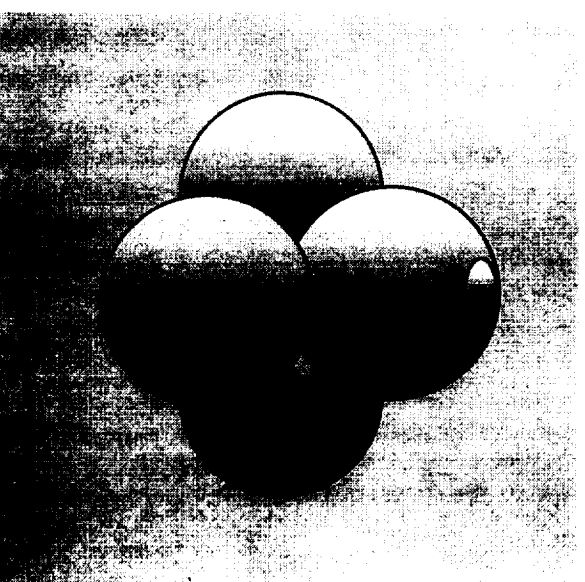


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CURRENT PULSE WELDING



TOP VIEW



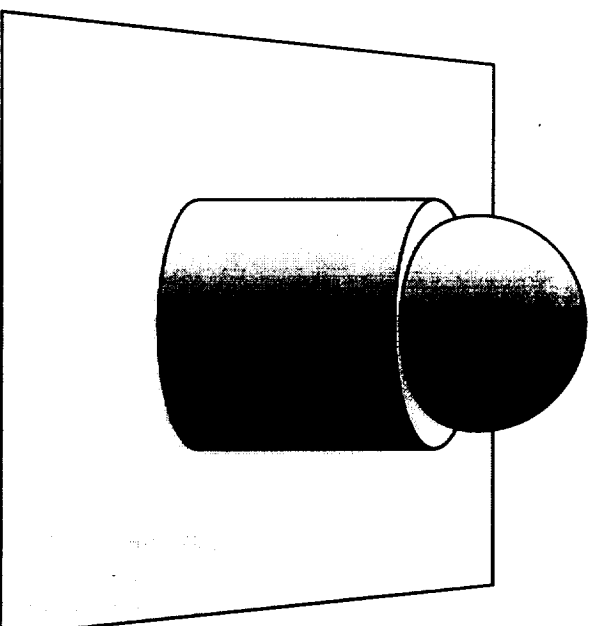
ANGLED VIEW

**MOUNTING PLATFORM IS DECOUPLED FROM THE
FASTENING MECHANISM BUT APPLYING THE HIGH
PRESSURE NEEDED IS DIFFICULT**



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SOLDER BALL METHOD



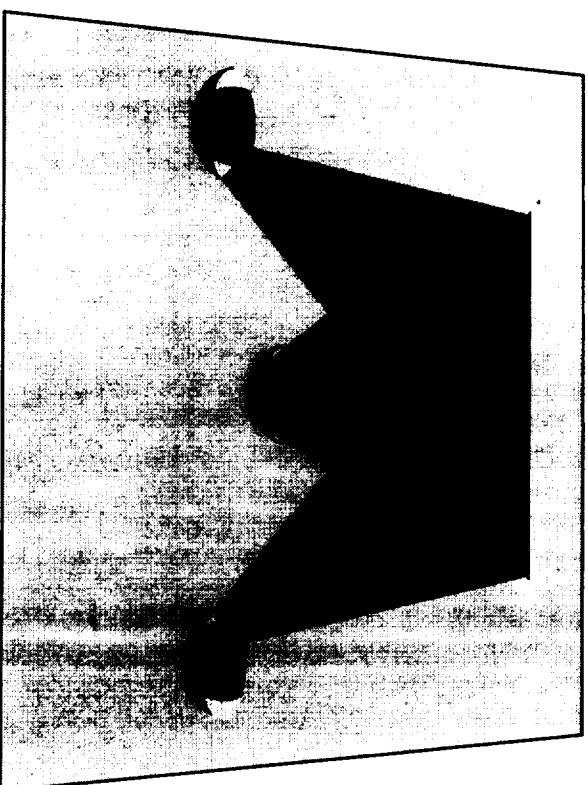
SOLDER BALL MOUNT

**MOVES WHEN COOLING, DIFFICULT TO CONTROL,
LABOR INTENSIVE**



CHALLENGES OF PACKAGING PHOTONIC DEVICES

TRIPOD POSITIONING AND LASER WELDING



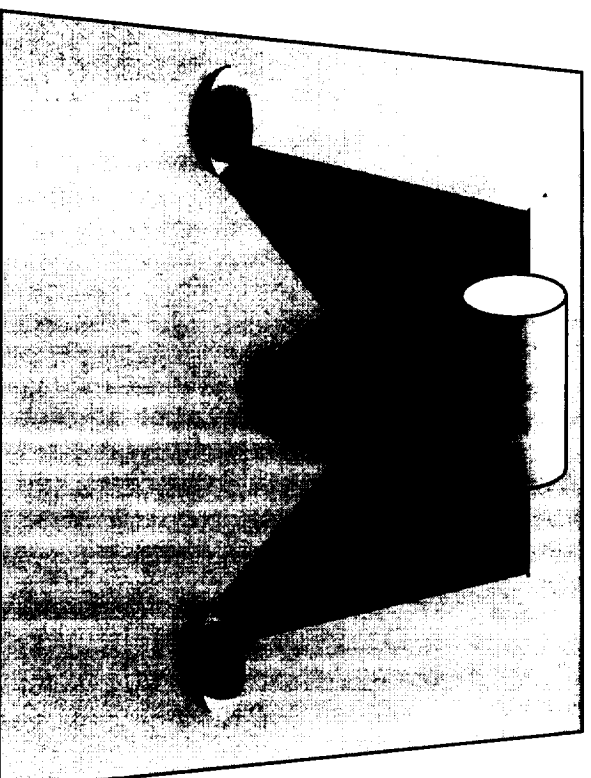
TRIPOD COMPONENT MOUNT

**MOUNTING PLATFORM IS DECOUPLED FROM THE
FASTENING MECHANISM, SIX DEGREES OF FREEDOM**



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TRIPOD POSITIONING AND LASER WELDING

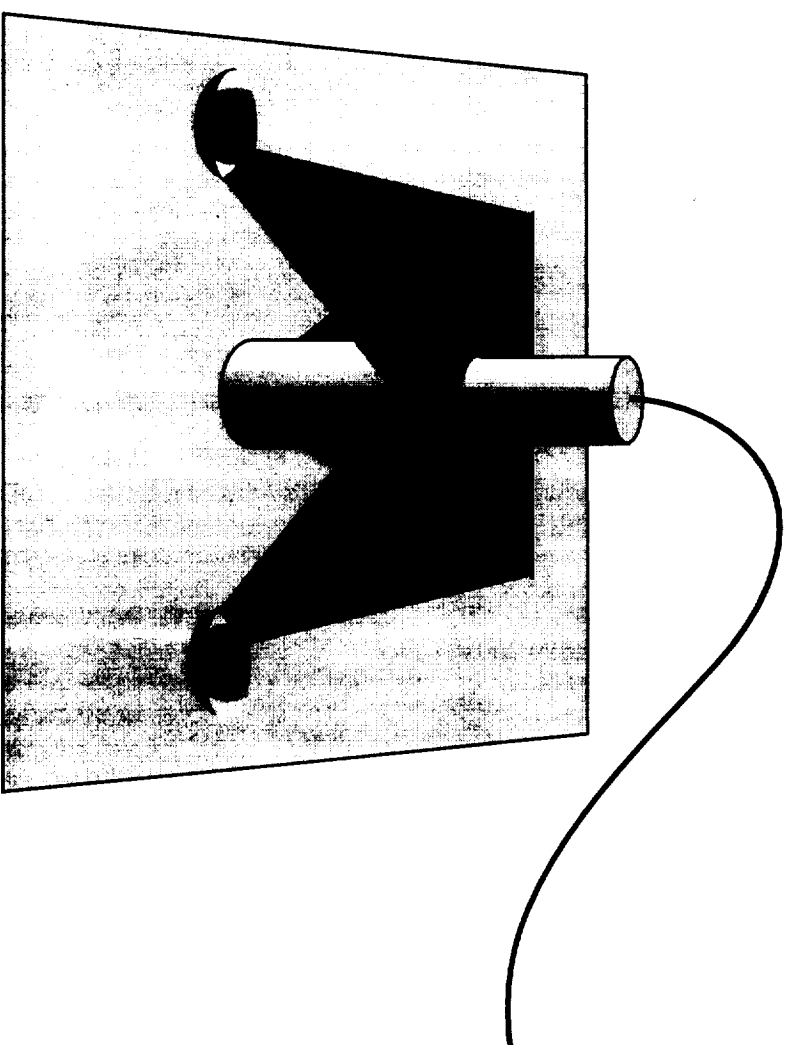


TRIPOD COMPONENT MOUNT

HORIZONTALLY MOUNTED COMPONENT



CHALLENGES OF PACKAGING PHOTONIC DEVICES TRIPOD POSITIONING AND LASER WELDING



VERTICALLY MOUNTED COMPONENT



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CONCLUSION

- **Presently used photonic packaging methods are labor intensive and often unreliable**
- **Studies have shown laser welding to be the superior fastening technology but it must be used in combination with a compatible positioning technology**
- **The right combination of positioning technology and fastening technology which will result in low cost, reliable photonic assemblies is yet to be developed**